onsemi

MOSFET – P-Channel, QFET[®]

-60 V, -17 A, 70 mΩ FQPF27P06

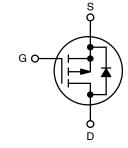
Description

This P-Channel enhancement mode power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

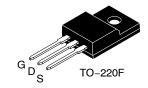
Features

- $-17 \text{ A}, -60 \text{ V}, \text{R}_{\text{DS(on)}} = 70 \text{ m}\Omega \text{ (Max.)} @ \text{V}_{\text{GS}} = -10 \text{ V}, \text{I}_{\text{D}} = -8.5 \text{ A}$
- Low Gate Charge (Typ. 33 nC)
- Low Crss (Typ. 120 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating

| V _{DSS} | R _{DS(ON)} MAX | I _D MAX | |
|------------------|-------------------------|--------------------|--|
| -60 V | 70 mΩ @ 10 V | –17 A | |

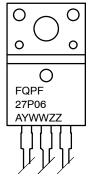






TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT

MARKING DIAGRAM



FQPF27P06 = Specific Device Code

| А | = Assembly Location | | |
|-----|--------------------------------|--|--|
| YWW | = Date Code (Year & Work Week) | | |
| ZZ | = Assembly Lot | | |

ORDERING INFORMATION

| Device | Package | Shipping |
|-----------|-----------------------|-------------------|
| FQPF27P06 | TO-220-3 (Pb-Free) | 1000 Units / Tube |

| Symbol | Pai | FQPF27P06 | Unit | |
|-----------------------------------|---|---------------------------------------|-------------|------|
| V _{DSS} | Drain-Source Voltage | Drain-Source Voltage | | V |
| Ι _D | Drain Current – Continuous ($T_c = 25^{\circ}C$) | | -17 | А |
| | | – Continuous (T _C = 100°C) | -12 | А |
| I _{DM} | Drain Current (Note 1) | – Pulsed | -68 | А |
| V _{GSS} | Gate-Source Voltage | | + 25 | V |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 560 | mJ |
| I _{AR} | Avalanche Current (Note 1) | | -17 | А |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 4.7 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | | -7.0 | V/ns |
| PD | Power Dissipation ($T_C = 25^{\circ}C$) | | 47 | W |
| | | – Derate above 25°C | 0.31 | W/∘C |
| T _J , T _{STG} | Operating and Storage Temperature Range | e | -55 to +175 | °C |
| TL | Maximum Lead Temperature for Soldering Purposes, 1/8" from Case for 5 Seconds | | 300 | °C |

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 2.25 mH, I_{AS} = -17 A, V_{DD} = -25 V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} ≤ -27 A, di/dt ≤ 300A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

THERMAL CHARACTERISTICS

| Symbol | Characteristic | Тур | Max | Unit |
|-----------------|---|-----|------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | - | 3.19 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | - | 62.5 | °C/W |

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|---|---|---|------|-------|------|------|
| OFF CHAR | ACTERISTICS | - | - | - | - | - |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \ \mu\text{A}$ | -60 | | - | V |
| $\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ / \Delta \text{T}_{\text{J}} \end{array}$ | Breakdown Voltage Temperature Coefficient | $I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$ | - | -0.06 | - | V/∘C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | _ | - | -1 | μA |
| | | $V_{DS} = -48$ V, $T_{C} = 150^{\circ}C$ | - | - | -10 | μA |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V_{GS} = -25 V, V_{DS} = 0 V | - | - | -100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | $V_{GS} = 25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | - | - | 100 | nA |
| ON CHARA | ACTERISTICS | - | | | | - |
| V _{GS(th}) | Gate Threshold Voltage | $V_{DS}=V_{GS},\ I_{D}=-250\ \mu A$ | -2.0 | - | -4.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | $V_{GS} = -10 \text{ V}, \text{ I}_{D} = -8.5 \text{ A}$ | - | 0.055 | 0.07 | Ω |
| 9 _{FS} | Forward Transconductance | V _{DS} = -30 V, I _D = -8.5 A (Note 4) | - | 12 | - | S |
| DYNAMIC | CHARACTERISTICS | • | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1.0 \text{ MHz}$ | - | 1100 | 1400 | pF |
| C _{oss} | Output Capacitance | | - | 510 | 660 | pF |
| C _{rss} | Reverse Transfer Capacitance | 7 | - | 120 | 155 | pF |
| SWITCHIN | G CHARACTERISTICS | • | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = -30 V, I _D = -13.5 A, R _G = 25 Ω (Note 4, 5) | - | 18 | 45 | ns |
| t _r | Turn-On Rise Time | | - | 185 | 380 | ns |
| t _{d(off)} | Turn-Off Delay Time | | - | 30 | 70 | ns |
| t _f | Turn-Off Fall Time | | - | 90 | 190 | ns |
| Qg | Total Gate Charge | $V_{DS} = -48 \text{ V}, I_D = -27 \text{ A}, V_{GS} = -10 \text{ V}$ (Note 4, 5) | - | 33 | 43 | nC |
| Q _{gs} | Gate-Source Charge | | - | 6.8 | - | nC |
| Q _{gd} | Gate-Drain Charge | 7 | - | 18 | - | nC |
| DRAIN-SC | DURCE DIODE CHARACTERISTICS AND MAX | IMUM RATING | | | | |
| I _S | Maximum Continuous Drain-Source Diode Forward Current | | - | - | -17 | Α |
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | - | - | -68 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -17 \text{ A}$ | - | - | -4.0 | V |
| t _{rr} | Reverse Recovery Time | $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -27 \text{ A},$ | - | 105 | - | ns |
| Qrr | Reverse Recovery Charge | dI _F / dt = 100 A/μs (Note 4) | _ | 0.41 | - | uC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse width \leq 300 µs, Duty cycle \leq 2%

μC

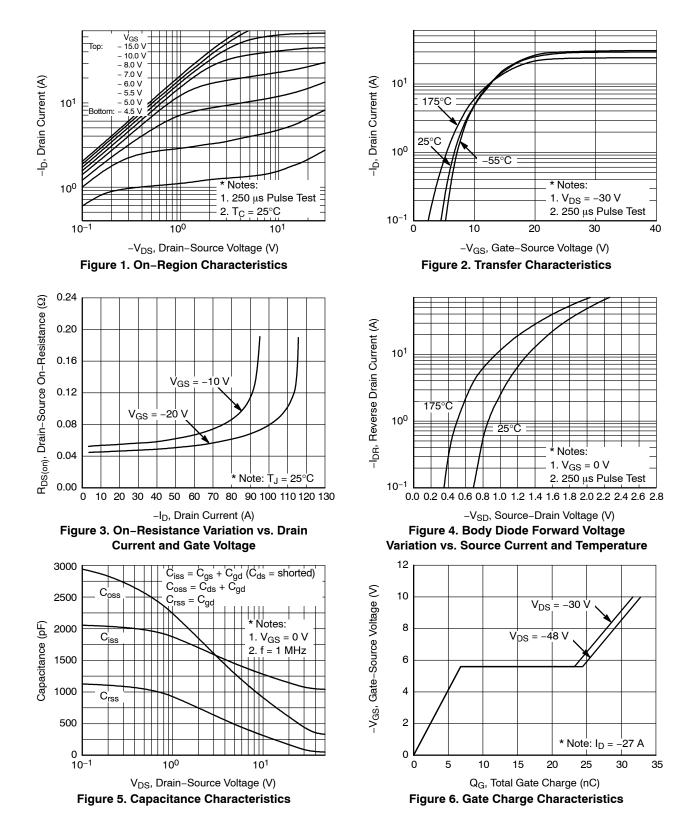
0.41

Reverse Recovery Charge

Q_{rr}

5. Essentially independent of operating temperature

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Continued)

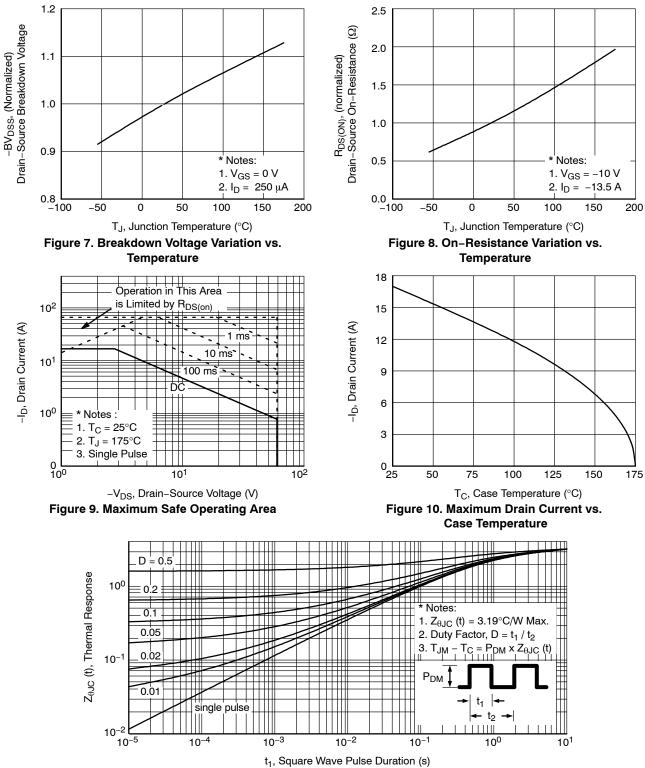


Figure 11. Transient Thermal Response Curve

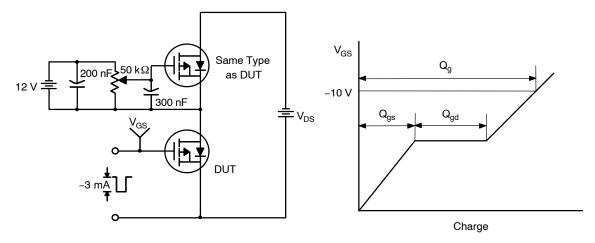


Figure 12. Gate Charge Test Circuit & Waveform

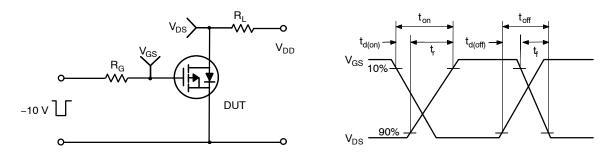


Figure 13. Resistive Switching Test Circuit & Waveforms

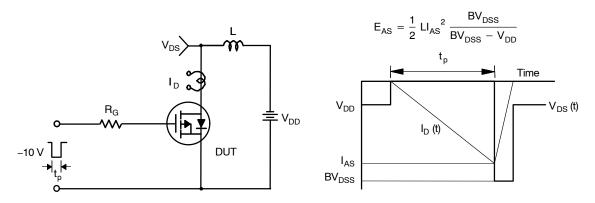


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

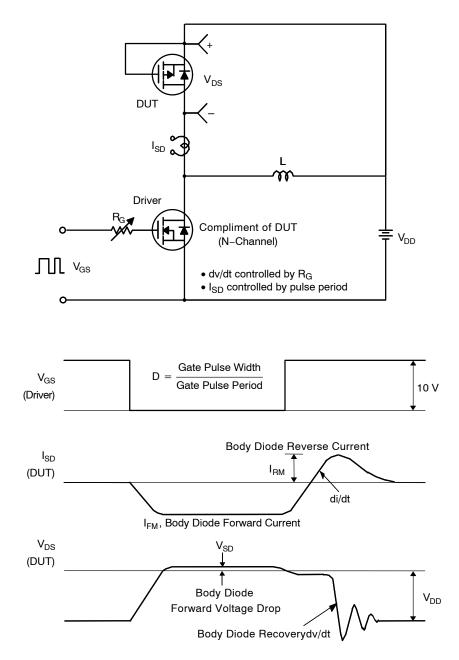
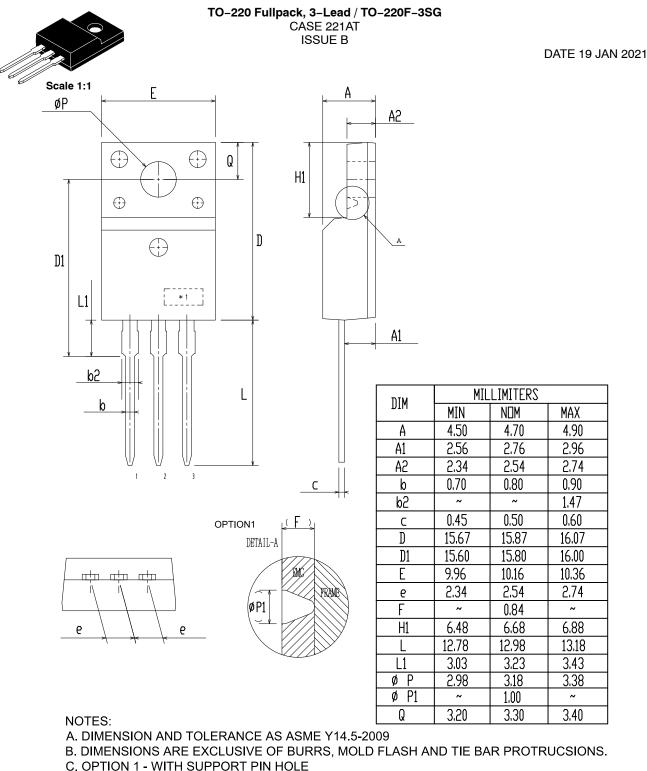


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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OPTION 2 - NO SUPPORT PIN HOLE

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|------------------|---|--|-------------|--|
| DESCRIPTION: | TO-220 FULLPACK, 3-LEAD / TO-220F-3SG | | PAGE 1 OF 1 | |
| | | | | |

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